© Co	terial Compositi opyright 2005. IPC, E national and Pan-Am	Bannockb	urn, Illinois. A	ll rights reserved u	under both	This docume level parts, t	ent is a decla the declaration	aration on enco	of the subsompasses a	stances v Ill lower	vithin the level mate	manufactur erials for w	rer listed i hich the n	tem. N nanufa	lote: if th cturer ha	e item is an as s engineering	sembly with low responsibility.
					Form Type Distribute						ous Materi	ials and Mfg Information					
Supplier Information	L																
Company name*			Company unique ID			Unique ID Authority					Response Date*						
nsemi												2025-06-08					
Contact Name			Title - Contact			Phone - Contact*					Email - Contact*						
Product-Env-Stewards			Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com						
Authorized Representative*			Title - Representative			Phone - Representative*					Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com						
Requester Item I	Requester Item Number Mfr Ite		n Number Mfr Item Name				Effective D	Date	e Version N		Manufacturing Site		,	Weigh	t*	UOM	Unit Type
			XDFN4 HZ 2.8V LDO 450 mA, Ultra-Low Noise and High PSRR		2025-06-08	8		ТНВ		1.434			mg	Each			
Aanufacturing Proce	ess Information																
Terminal Plating	Terminal Plating / Grid Array Material		erminal Base Alloy J-S		J-STD-020 MSI	TD-020 MSL Rating		Peak Process Body Temperatu		peratur	e Max Time at Peak Temper		Temperat	ure 1	Number	of Reflow Cyc	les
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)) (no C	CU Alloy 1		1		260		С		30		seconds 3		3		
Comments																	
vel 1 - maximum time at j	peak temperature d	uring sol	dering is 10-3	0 seconds													
or more information rega	rding material com	position p	please refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.09	mg	Supplier	Silicon (Si)	7440-21-3		0.09	mg
Die Attach Tape	0.13	mg	Supplier	Oxirane, (chloromethyl)-, homopolymer	24969-06-0		0.0195	mg
			Supplier	2-Propenoic acid, 2-methyl-, polymer with butyl 2-propenoate and methyl 2- methyl-2-propenoate	25035-69-2		0.0195	mg
			Supplier	Proprietary	Proprietary Data		0.013	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0585	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0195	mg
Lead Frame	0.58	mg	Supplier	Tin (Sn)	7440-31-5		0.0014	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0013	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0014	mg
			Supplier	Copper (Cu)	7440-50-8		0.5758	mg
Mold Compound-Black	0.6	mg	Supplier	Epoxy and Phenolic Resin	40216-08-8		0.048	mg
			Supplier	Carbon Black (C)	1333-86-4		0.003	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.012	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.519	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.018	mg
Plating	0.004	mg	Supplier	Palladium (Pd)	7440-05-3		0.0001	mg
			В	Nickel (Ni)	7440-02-0		0.0035	mg
			Supplier	Gold (Au)	7440-57-5		0.0004	mg
Wire Bond - Au	0.03	mg	Supplier	Gold (Au)	7440-57-5		0.03	mg